

SSPS7331P-VB Datasheet P-Channel 30 V (D-S) MOSFET

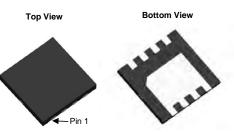
V _{DS}		-30	V
R _{DS(on),typ}	V _{GS} =10V	11	mΩ
R _{DS(on),typ}	V _{GS} =4.5V	18	mΩ
ID	• 	-45	А

FEATURES

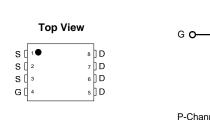
- Halogen-free According to IEC 61249-2-21
 Definition
- Trench Power MOSFET
- Low Thermal Resistance Power
 Package with Small Size and Low 1.07 mm
 Profile
- 100 % $\rm R_g$ and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- · Load Switch
- Adaptor Switch
- Notebook PC



DFN 3x3 EP



Pin 1			P-Channel MOSFET		
ABSOLUTE MAXIMUM RATINGS ($T_A = 23$	5 °C, unless oth	erwise noted)			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	- 30	v	
Gate-Source Voltage		V _{GS}	± 20	V	
	T _C = 25 °C		- 45		
Continuous Drain Current (T _J = 150 °C)	T _C = 70 °C	I _D	- 30		
Continuous Drain Guirent (1) = 130°C)	T _A = 25 °C	D	- 14.4 ^{a, b}		
	T _A = 70 °C		- 11.5 ^{a, b}	Α	
Pulsed Drain Current		I _{DM}	- 60		
Continuous Source-Drain Diode Current	T _C = 25 °C	la la	- 35 ^e		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	- 3.2 ^{a, b}		
Avalanche Current	L = 0.1 mH	I _{AS}	- 25		
Single-Pulse Avalanche Energy		E _{AS}	31.25	mJ	
	T _C = 25 °C		52		
Maximum Power Dissipation	T _C = 70 °C	P _D	43	w	
	T _A = 25 °C		3.8 ^{a, b}	vv	
	T _A = 70 °C		2.4 ^{a, b}		
Operating Junction and Storage Temperature Range	•	T _J , T _{stg}	- 50 to 150	°C	
Soldering Recommendations (Peak Temperature) ^{c, d}			260		

Notes:

a. Surface mounted on 1" x 1" FR4 board.

c.Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

d.Package limited.

e.Based on T $_{\rm C}$ = 25 °C

b. t = 10 s.



THERMAL RESISTANCE RATINGS Parameter Symbol Typical Maximum Unit Maximum Junction-to-Ambienta, b t ≤ 10 s R_{thJA} 33 26 °C/W 1.9 2.4 Maximum Junction-to-Case (Drain) Steady State R_{thJC}

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. Maximum under Steady State conditions is 81 °C/W.

Symbol V _{DS} ΔV _{DS} /T _J	Test Conditions V _{GS} = 0 V, I _D = - 250 μA	Min.	Тур.	Max.	Unit	
$\Delta V_{DS}/T_{J}$	$V_{aa} = 0 V_{ab} = -250 \mu A$					
$\Delta V_{DS}/T_{J}$			1	1	<i>.</i>	
	V _{GS} = 0 V, I _D = - 200 μA	- 30			V	
	I _D = - 250 μA		- 20		mV/°C	
$\Delta V_{GS(th)}/T_J$	2 .		5			
V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	- 1.5		- 2.8	V	
I _{GSS}				± 100	nA	
loce				- 1	μΑ	
.033				- 10		
I _{D(on)}		- 20			A	
Back	V _{GS} = - 10 V, I _D = - 14.4 A		11		mΩ	
US(on)	V _{GS} = - 4.5 V, I _D = - 11.5 A		18			
9 _{fs}	V _{DS} = - 15 V, I _D = - 14.4 A		37		S	
	·				•	
C _{iss}			2000		pF	
	V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz		385			
C _{rss}			322			
	$V_{DS} = -15 V, V_{GS} = -10 V, I_{D} = -14.4 A$			15		
Q_{g}				14	nC	
Q _{as}	V _{DS} = - 15 V, V _{GS} = - 4.5 V, I _D = - 14.4 A			7		
				9		
0	f = 1 MHz	0.4	1.8	3.6	Ω	
0			50	75	- ns	
	$V_{DD} = -15 \text{ V}, \text{ R}_{1} = 1.5 \Omega$		43	65		
t _{d(off)}	$I_D \cong$ - 10 A, V_{GEN} = - 4.5 V, R_a = 1 Ω		30	45		
			14	21		
			14	21		
	V _{DD} = - 15 V, R _I = 1.5 Ω		9	18		
	$I_D \cong -10 \text{ A}, \text{ V}_{\text{GEN}} = -10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		36	54		
			10	20		
-				I		
	T _C = 25 °C			- 35 ^e		
	, , , , , , , , , , , , , , , , , , ,			- 60	A	
-	I _F = - 10 A		- 0.8		V	
	' 				ns	
	1 F		-		nC	
	l _F = - 10 A, dl/dt = 100 A/μs, T _J = 25 °C			.0		
	4		-		ns	
	I _{GSS} I _{DSS} I _{D(on)} R _{DS(on)} g _{fs}	$ \begin{array}{c c} I_{GSS} & V_{DS} = 0 \ V, \ V_{GS} = \pm 20 \ V \\ \hline V_{DS} = -30 \ V, \ V_{GS} = 0 \ V, \ T_J = 55 \ ^{\circ}C \\ \hline I_{D(on)} & V_{DS} \leq -5 \ V, \ V_{GS} = -10 \ V \\ \hline V_{DS} \leq -5 \ V, \ V_{GS} = -10 \ V \\ \hline V_{DS} = -10 \ V, \ I_D = -14.4 \ A \\ \hline V_{GS} = -4.5 \ V, \ I_D = -11.5 \ A \\ \hline V_{DS} = -15 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz \\ \hline C_{rss} & V_{DS} = -15 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz \\ \hline C_{rss} & V_{DS} = -15 \ V, \ V_{GS} = -10 \ V, \ I_D = -14.4 \ A \\ \hline Q_{gd} & V_{DS} = -15 \ V, \ V_{GS} = -10 \ V, \ I_D = -14.4 \ A \\ \hline Q_{gd} & V_{DS} = -15 \ V, \ V_{GS} = -10 \ V, \ I_D = -14.4 \ A \\ \hline Q_{gd} & V_{DS} = -15 \ V, \ V_{GS} = -10 \ V, \ I_D = -14.4 \ A \\ \hline Q_{gd} & V_{DS} = -15 \ V, \ V_{GS} = -4.5 \ V, \ I_D = -14.4 \ A \\ \hline Q_{gd} & I_D \equiv -15 \ V, \ V_{GS} = -4.5 \ V, \ I_D = -14.4 \ A \\ \hline Q_{gd} & I_D \equiv -10 \ A, \ V_{GEN} = -4.5 \ V, \ R_g = 1 \ \Omega \\ \hline I_D \equiv -10 \ A, \ V_{GEN} = -4.5 \ V, \ R_g = 1 \ \Omega \\ \hline I_D \equiv -10 \ A, \ V_{GEN} = -10 \ V, \ R_g = 1 \ \Omega \\ \hline I_D \equiv -10 \ A, \ V_{GEN} = -10 \ V, \ R_g = 1 \ \Omega \\ \hline I_D \equiv -10 \ A, \ V_{GEN} = -10 \ V, \ R_g = 1 \ \Omega \\ \hline V_{SD} & I_F = -10 \ A, \ I_F = -10 \ A \\ \hline I_F = -10 \ A, \ I_F = -10 \ A \\ \hline V_{SD} & I_F = -10 \ A \\ $	$\begin{array}{c c c c c c c } I_{GSS} & V_{DS} = 0 V, V_{GS} = \pm 20 V & & & \\ \hline V_{DS} = -30 V, V_{GS} = 0 V & & & \\ \hline V_{DS} = -30 V, V_{GS} = 0 V, T_{J} = 55 \ ^{\circ}\text{C} & & \\ \hline V_{DS} = -30 V, V_{GS} = 0 V, T_{J} = 55 \ ^{\circ}\text{C} & & \\ \hline V_{DS} = -30 V, V_{DS} = -10 V & & -20 & \\ \hline V_{DS} = -5 V, V_{GS} = -10 V, I_{D} = -14.4 \ ^{\circ}\text{A} & & \\ \hline V_{DS} = -15 V, I_{D} = -14.4 \ ^{\circ}\text{A} & & \\ \hline & & \\ \hline \\ \hline \\ \hline \\ \hline \\ \hline \\ \hline \\ \hline$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	

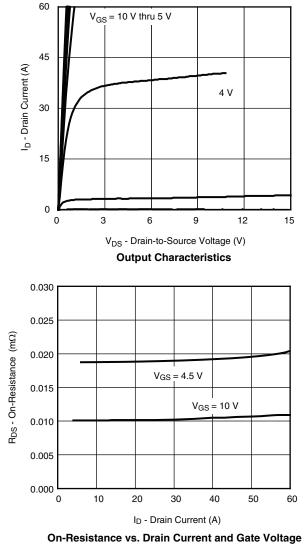
Notes:

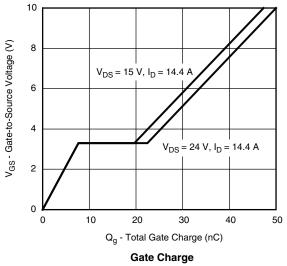
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

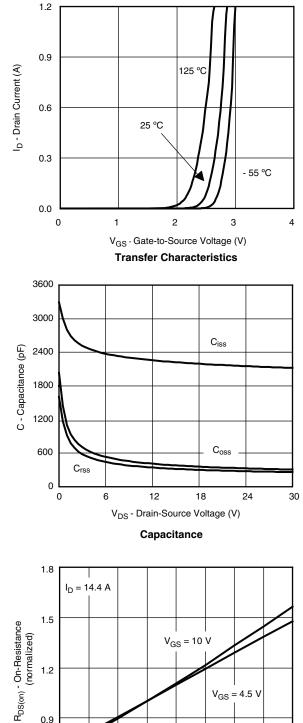
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





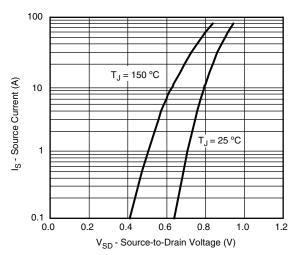




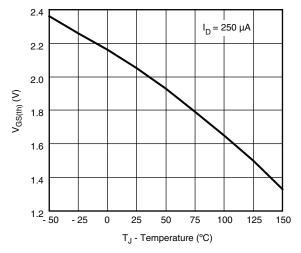
0.9 0.6 - 50 - 25 0 25 50 75 100 125 150 T_J - Junction Temperature (°C)

On-Resistance vs. Junction Temperature

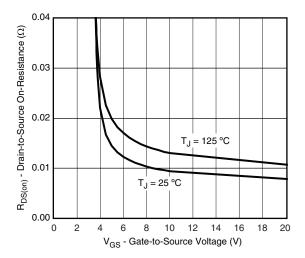




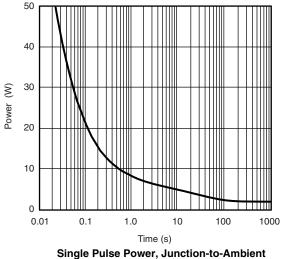


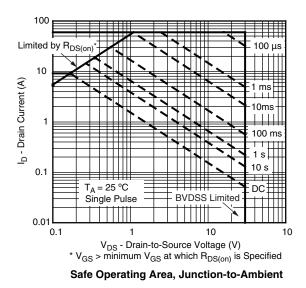


Threshold Voltage

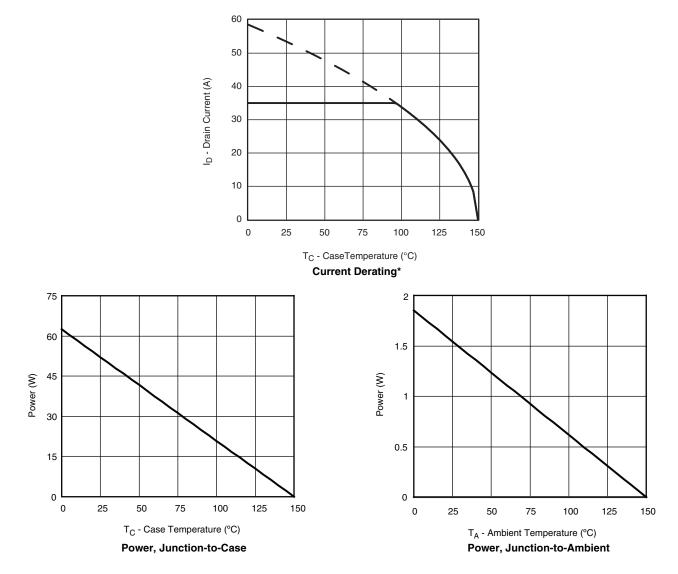


On-Resistance vs. Gate-to-Source Voltage



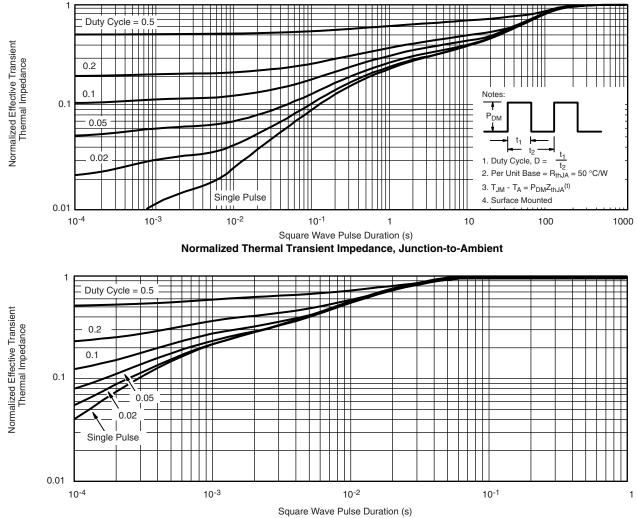






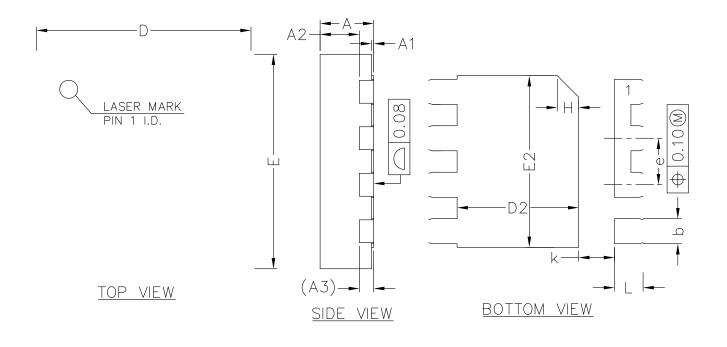
* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Case

WBsemi www.VBsemi.com





<u>SIDE VIEW</u>

			,
SYMBOL	MIN	NOM	MAX
А	0.70	0.75	0.80
A1	0.00	0.02	0.05
A2	0.50	0.55	0.60
A3		0.20REF	
b	0.30	0.35	0.40
D	2.90	3.00	3.10
E	2.90	3.00	3.10
D2	1.60	1.70	1.80
E2	2.30	2.40	2.50
е	0.55	0.65	0.75
К	0.40	0.50	0.60
L	0.35	0.40	0.45

COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)



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